

R-IN32M3-EC/CL

R18AN0039EJ0126 Rev.1.26 Dec 27, 2018

Driver/Middleware Set for R-IN32M3-EC/CL Release Note

Summary

This document describes the package contents and operating environment of this product.

Please be sure to read before use.

For details on how to use each sample software, middleware etc, please refer to the related documents below.

Related documents

R18UZ0003EJ****	R-IN32M3-EC User's Manual
R18UZ0005EJ****	R-IN32M3-CL User's Manual
R18UZ0024EJ****	R-IN32M3-CL Development Tools Startup Manual
R18UZ0011EJ****	R-IN32M3 Series Programming Manual (OS edition)
R18UZ0021EJ****	R-IN32M3 Series User's Manual (Board design edition)
R18UZ0009EJ****	R-IN32M3 Series Programming Manual (Driver edition)
R18UZ0007EJ****	R-IN32M3 Series User's Manual Periphral Functions
R18UZ0056EJ****	R-IN32 Series User's Manual CC-Link remote device station

Last four digits of document number (described as ****) indicate version information of each document.

Please download the latest document from our web site and refer to it.

Contents

1.	Introduction	2
2.	Package Contents	2
3.	Folder structure	2
4.	Operating environment	3
5.	Website and Support	4

1. Introduction

CC-Link remote device station package for R-IN32M3-EC/-CL is a software package that summarizes the sample applications of CC-Link remote device stations Ver 1 and Ver 2 using RIN32m3-EC/CL.

This package is used in combination with driver and middleware package. please move CCSV 1 / CCSV 2 of this package to the \ Project of middleware / driver and use it.

2. Package Contents

The sample applications, libraries, middleware, and peripheral function drivers included in this package are shown below.

Sample application

No.	Sample application name
1	CC-Link Ver.1 for sample application
2	CC-Link Ver.2 for sample application

3. Folder structure

Folder structure of this package is shown below.

```
T<sub>O</sub>P
١
             <--- CC-Link Version 1
+-- CCSV1
      +-readme. txt
      +-- ARM
      +-- GCC
      +-- GX_works2 [Sample Project File for GX Works2]
      +-- IAR
  - CCSV2
             <--- CC-Link version 2
      +-readme. txt
      +-- ARM
      +-- GCC
      +-- GX_works2 [Sample Project File for GX Works2]
      +-- IAR
```

4. Operating environment

The operating environment of this package is shown below.

Target device

R-IN32M3-EC

R-IN32M3-CL

Target board

R-IN32M3-EC TESSERA Board (TS-R-IN32M3-EC) R-IN32M3-CL TESSERA Board (TS-R-IN32M3-CL)

- Development environment
 - Compiler

IAR Embedded Workbench for ARM 7.80

Debugger

IAR Embedded Workbench for ARM 7.80

≻ ICE

I-jet / JTAGjet-Trace (IAR)

5. Website and Support

Renesas Electronics Website http://www.renesas.com/

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Change history

Version	Changes
V1.2.6	[Changed]
(2018/11/19)	/CCSV1/main.c
	/CCSV2/main.c
	- IOTENSU changed to low fixed.
	"Number of I/O points fixed to 32 points" can not be used.
V1.2.5	[Add]
(2017/12/12)	- Added RUN LED on / off control by master station version.
	- RUN LED off when the master station is Ver.1
	- RUN LED on when the master station is other than Ver.1
	- RUN LED turns off when communication timeout occurs.
	- Added initialization port setting for RUN LED control.

V1.2.4 The following type name of products correspond with "Revision 2" and the other (2015/11/30) type name of products with "Revision 1" - Revision 2 R-IN32M3-EC: MC-10287BF1-HN4-M1-A/MC-10287BF1-HN4-A R-IN32M3-CL: UPD60510BF1-HN4-A / UPD60510BF1-HN4-M1-A [Changed] /CCSV1/IAR/boot_norflash.icf /CCSV1/IAR/boot serialflash.icf /CCSV1/IAR/iram.icf /CCSV1/ARM/scat boot extrom.ld /CCSV1/ARM/scat_boot_iram.ld /CCSV1/ARM/scat boot sflash.ld /CCSV1/GCC/scat boot extrom.ld /CCSV1/GCC/scat boot iram.ld /CCSV1/GCC/scat boot sflash.ld /CCSV2/IAR/boot_norflash.icf /CCSV2/IAR/boot serialflash.icf /CCSV2/IAR/iram.icf /CCSV2/ARM/scat boot extrom.ld /CCSV2/ARM/scat boot iram.ld /CCSV2/ARM/scat boot sflash.ld /CCSV2/GCC/scat_boot_extrom.ld /CCSV2/GCC/scat boot iram.ld /CCSV2/GCC/scat boot sflash.ld There are two types of mapping files and startup routine in this sample software. One is for "Revision 1" (CPU access area limitation *notice) The other is for "Revision 1" (no limitation) Mapping file(*.ld) and startup routine (startup_RIN32M3.c) for ARM are updated. Before: The common area is assigned for stack and Heap. After: Dedicated area is assigned for Heap. Especially GCC, pleae use mapping file and startup toutine for same Revision. Mapping file for Revision 1 r-in32m3 samplesoft/Device/Renesas/RIN32M3/Source/Templates/IAR/rev1 r-in32m3_samplesoft/Device/Renesas/RIN32M3/Source/Templates/GCC/rev1 r-in32m3 samplesoft/Device/Renesas/RIN32M3/Source/Templates/ARM/rev1 Mapping file for Revision 2 r-in32m3 samplesoft/Device/Renesas/RIN32M3/Source/Templates/IAR/rev2 r-in32m3 samplesoft/Device/Renesas/RIN32M3/Source/Templates/GCC/rev2 r-in32m3_samplesoft/Device/Renesas/RIN32M3/Source/Templates/ARM/rev2 *notice Please refer below documentation http://documentation.renesas.com/doc/products/mpumcu/tu/tnrina001be.pdf V1.2.3 [Changed] (2015/8/31) /CCSV1/GCC/scat boot iram.ld /CCSV2/GCC/scat boot iram.ld

- Remove unnecessary definition of linker file.

V1.2.2	[Changed]
(2015/5/19)	- Update EWARM project file and makefiles.
	- Change the processing of timeout setting function.
	- "RIN32M3_CL" is defined.
V1.2.1	[Add]
(2015/2/13)	- Add port setting for R-IN32M3-EC Evaluation Board.
	- Add sample code for bidirectional communication.
	[Changed]
	- Change interrupt port to INTPZ7 in CCSV2.
V1.2.0	[Changed]
(2015/1/23)	Correspondence of Conformance Test
	- Additional aplication buffer
	- Disable loopback function (initial state)
V1.1.0	[Fixed]
(2014/1/16)	- Fix how to monitor INTPZ1 pin in CCSV2.
	- Fix port control for RS-485 transceiver.
	[Changed]
	- Update EWARM project file and makefiles.
	- Delete CC-Link IE WDT disable sequnece.
	- Port setting sequneces.
V1.0.0	First release
(2016/1/29)	

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
 - In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

 The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

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